

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT3743832

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ANANDA H. KUMAR	01/29/2016
TUE NGUYEN	02/09/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SIRAMICS INC.
<b>Street Address:</b>	1999 BLACKFOOT DRIVE
<b>City:</b>	FREMONT
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	94539
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	13557209
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b> <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	4159355741
<b>Email:</b>	vnguyen@patent2ip.com
<b>Correspondent Name:</b>	TUE NGUYEN
<b>Address Line 1:</b>	496 OLIVE AVE.
<b>Address Line 4:</b>	FREMONT, CALIFORNIA 94539
<b>ATTORNEY DOCKET NUMBER:</b>	AHK006
<b>NAME OF SUBMITTER:</b>	TUE NGUYEN
<b>SIGNATURE:</b>	/Tue Nguyen/
<b>DATE SIGNED:</b>	02/17/2016
<b>Total Attachments: 2</b> source=AHK006#page1.tif source=AHK006#page2.tif	

## ASSIGNMENT

Whereas, the undersigned Inventor, **Ananda H. Kumar**, a resident of US, has invented a certain new and useful improvement in:

### **Composite substrates of silicon and ceramic**

and has executed a declaration or oath for an application for a United States patent disclosing and identifying the invention, the invention has been filed on July 25, 2012, Appl. Ser. No 13/557,209, with docket number AIHK006.

Whereas, **SIRAMICS Inc.**, hereafter referred to as "Assignee", whose mailing address is 1999 Blackfoot Drive, Fremont, CA 94539, USA, wishes to acquire the entire right, title and interest in the same.

Now, therefore, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee, said Inventor does hereby sell, assign, and transfer unto said Assignee the entire right, title and interest

(a) in and to said invention and said application, including any provisional application for which said application claims benefit;

(b) in and to all rights to apply in any or all countries in the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patent pursuant to the International Convention for the Protection of Industrial Property or pursuant to other convention, treaty, agreement, or understanding;

(c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications, including any provisional application for which said applications claim benefit;

(d) in and to each and every reissue or extension of any of said patents; and

(e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, his or her respective heirs, legal representatives and assigns.

IN WITNESS WHEREOF, said Inventor has executed this instrument on the date as given below and delivered this instrument to said Assignee:

1/29/14

Date

*Ananda H. Kumar*

Ananda H. Kumar

PATENT

REEL: 037758 FRAME: 0959

## ASSIGNMENT

Whereas, the undersigned Inventor, **Tue Nguyen**, a resident of US, has invented a certain new and useful improvement in:

### **Composite substrates of silicon and ceramic**

and has executed a declaration or oath for an application for a United States patent disclosing and identifying the invention, the invention has been filed on July 25, 2012, Appl. Ser. No 13/557,209, with docket number AHK006.

Whereas, **SIRAMICS Inc.**, hereafter referred to as "Assignee", whose mailing address is 1999 Blackfoot Drive, Fremont, CA 94539, USA, wishes to acquire the entire right, title and interest in the same.

Now, therefore, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee, said Inventor does hereby sell, assign, and transfer unto said Assignee the entire right, title and interest

(a) in and to said invention and said application, including any provisional application for which said application claims benefit;

(b) in and to all rights to apply in any or all countries in the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patent pursuant to the International Convention for the Protection of Industrial Property or pursuant to other convention, treaty, agreement, or understanding;

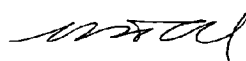
(c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications, including any provisional application for which said applications claim benefit;

(d) in and to each and every reissue or extension of any of said patents; and

(e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, his or her respective heirs, legal representatives and assigns.

IN WITNESS WHEREOF, said Inventor has executed this instrument on the date as given below and delivered this instrument to said Assignee:



Date: 2016-02-09

Tue Nguyen